DATA SHEET

PCA9553

4-bit I^{2}C-bus LED driver with
programmable blink rates

Philips
Semiconductors

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4-bit I²C-bus LED driver with programmable blink rates

PCA9553

Expanders like the PCF8574 or PCA9554, the bus master must send repeated commands to turn the LED on and off. This greatly increases the amount of traffic on the I²C-bus and uses up one of the master's timers. The PCA9553 LED Blinker instead requires only the initial set-up command to program BLINK RATE 1 and BLINK RATE 2 (i.e., the frequency and duty cycle). From then on, only one command from the bus master is required to turn each individual open drain output ON, OFF, or to cycle at BLINK RATE 1 or BLINK RATE 2. Maximum output sink current is 25 mA per bit and 100 mA per package.

Any bits not used for controlling the LEDs can be used for General Purpose Parallel Input/Output (GPIO) expansion.

Power-On Reset (POR) initializes the registers to their default state, all zeroes, causing the bits to be set HIGH (LED off).

Due to pin limitations, the PCA9553 is not featured with hardware address pins. The PCA9553/01 and the PCA9553/02 have different fixed I²C-bus addresses allowing operation of both on the same bus.
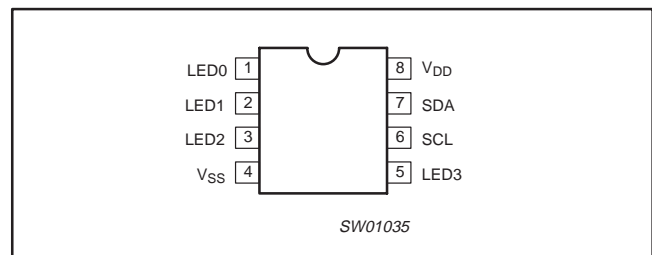
FEATURES

- 4 LED drivers (on, off, flashing at a programmable rate)
- 2 selectable, fully programmable blink rates (frequency and duty cycle) between 0.172 Hz and 44 Hz (5.82 and 0.023 seconds)
- Input/outputs not used as LED drivers can be used as regular GPIOs
- Internal oscillator requires no external components
- I²C-bus interface logic compatible with SMBus
- Internal power-on reset
- Noise filter on SCL/SDA inputs
- 4 open drain outputs directly drive LEDs to 25 mA
- Controlled edge rates to minimize ground bounce
- No glitch on power-up
- Supports hot insertion
- Low stand-by current
- Operating power supply voltage range of 2.3 V to 5.5 V
- 0 to 400 kHz clock frequency
- ESD protection exceeds 2000 V HBM per JESD22-A114, 150 V MM per JESD22-A115 and 1000 V CDM per JESD22-C101
- Latch-up testing is done to JEDEC Standard JESD78 which exceeds 100 mA
- Packages offered: SO8, TSSOP8 (MSOP8), HVSON8

DESCRIPTION

The PCA9553 LED Blinker blinks LEDs in I²C-bus and SMBus applications where it is necessary to limit bus traffic or free up the I²C-bus master's (MCU, MPU, DSP, chipset, etc.) timer. The uniqueness of this device is the internal oscillator with two programmable blink rates. To blink LEDs using normal I/O

PIN CONFIGURATION

Figure 1. Pin configuration

PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
1	LED0	LED driver 0
2	LED1	LED driver 1
3	LED2	LED driver 2
4	V_{SS}	supply ground
5	LED3	LED driver 3
6	SCL	serial clock line
7	SDA	serial data line
8	V_{DD}	supply voltage

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	ORDER CODE	TOPSIDE MARK	DRAWING NUMBER
8-pin plastic SO	−40 °C to +85 °C	PCA9553D/01	P9553/1	SOT96-1
8-pin plastic SO	−40 °C to +85 °C	PCA9553D/02	P9553/2	SOT96-1
8-pin plastic TSSOP (MSOP)	−40 °C to +85 °C	PCA9553DP/01	P53/1	SOT505-1
8-pin plastic TSSOP (MSOP)	−40 °C to +85 °C	PCA9553DP/02	P53/2	SOT505-1
8-pin plastic HVSON	−40 °C to +85 °C	PCA9553TK	P53	SOT908-1

Standard packing quantities and other packaging data are available at www.standardics.philips.com/packaging.
PCA9553TK uses version /01 address.

4-bit I²C-bus LED driver with programmable blink rates   PCA9553
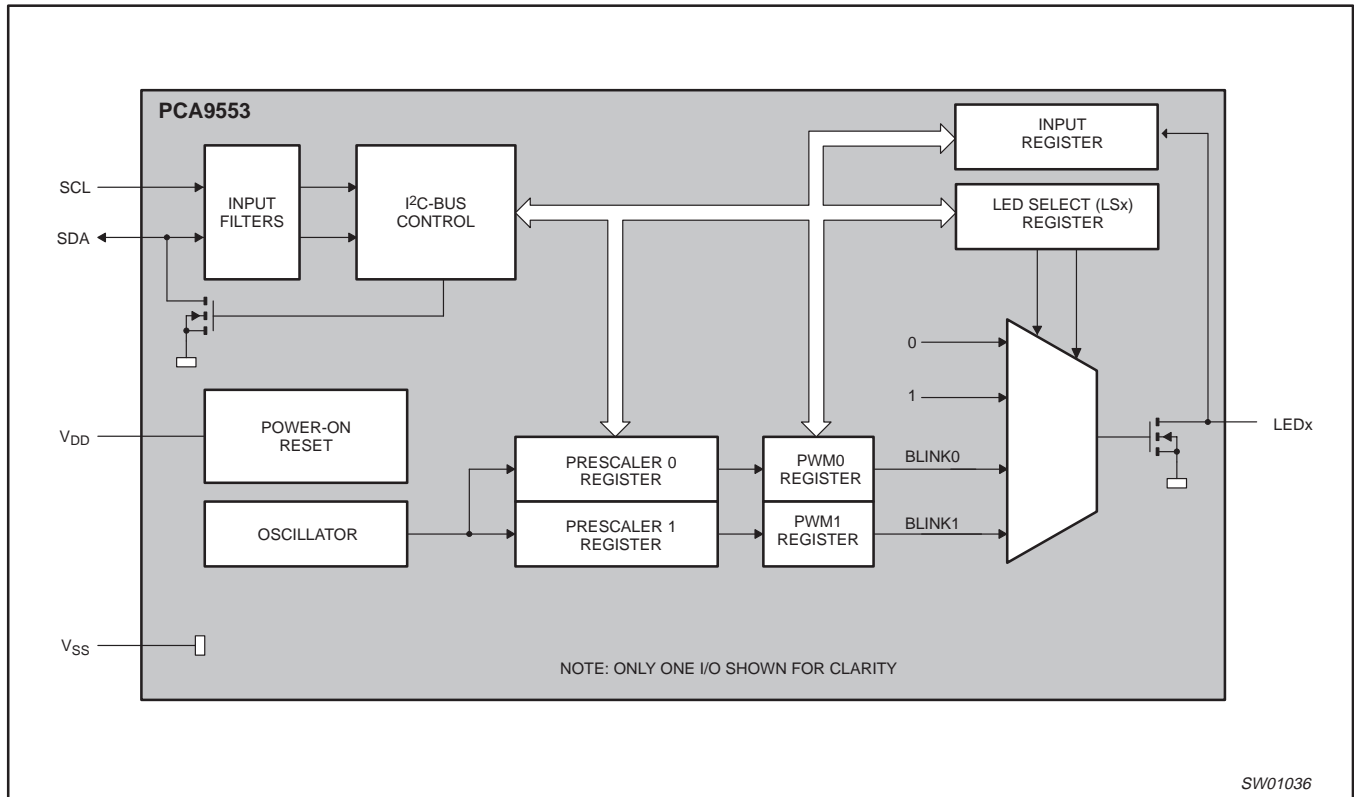
BLOCK DIAGRAM

Figure 2. Block diagram

4-bit I²C-bus LED driver with programmable blink rates   PCA9553

DEVICE ADDRESSING

Following a START condition the bus master must output the address of the slave it is accessing. The address of the PCA9553/01 is shown in Figure 3 and PCA9553/02 in Figure 4.
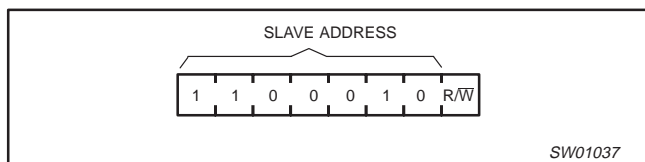
PCA9553TK uses the version /01 address.

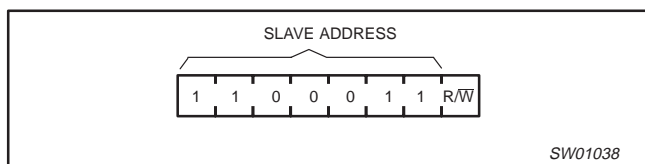**Figure 3. Slave address — PCA9553/01**

Figure 4. Slave address — PCA9553/02

The last bit of the address byte defines the operation to be performed. When set to logic 1 a read is selected, while a logic 0 selects a write operation.

CONTROL REGISTER

Following the successful acknowledgement of the slave address, the bus master will send a byte to the PCA9553 which will be stored in the Control Register.
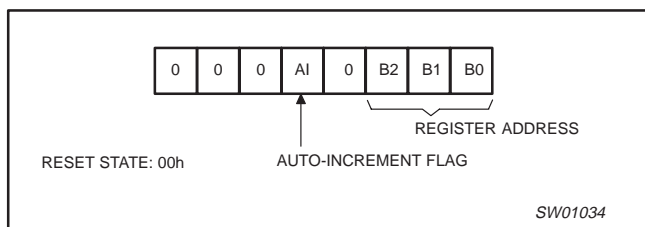

Figure 5. Control register

The lowest 3 bits are used as a pointer to determine which register will be accessed.

If the auto-increment flag is set, the three low order bits of the Control Register are automatically incremented after a read or write. This allows the user to program the registers sequentially. The contents of these bits will rollover to '000' after the last register is accessed.

When auto-increment flag is set (AI = 1) and a read sequence is initiated, the sequence must start by reading a register different from '0' (B2 B1 B0 ≠ 0 0 0)

Only the 3 least significant bits are affected by the AI flag.

Unused bits must be programmed with zeroes.

Control Register definition

B2	B1	B0	REGISTER NAME	TYPE	REGISTER FUNCTION
0	0	0	INPUT	read	input register
0	0	1	PSC0	read/write	frequency prescaler 0
0	1	0	PWM0	read/write	PWM register 0
0	1	1	PSC1	read/write	frequency prescaler 1
1	0	0	PWM1	read/write	PWM register 1
1	0	1	LS0	read/write	LED selector

REGISTER DESCRIPTION

INPUT — INPUT REGISTER

					LED 3	LED 2	LED 1	LED 0
bit	7	6	5	4	3	2	1	0
default	0	0	0	0	X	X	X	X

The INPUT register reflects the state of the device pins. Writes to this register will be acknowledged but will have no effect.

NOTE: The default value "X" is determined by the externally applied logic level, normally '1' when used for directly driving LED with pull-up to V_{DD}.

PSC0 — FREQUENCY PRESCALER 0

bit	7	6	5	4	3	2	1	0
default	1	1	1	1	1	1	1	1

PSC0 is used to program the period of the PWM output.

The period of BLINK0 $= \dfrac{(PSC0\ +\ 1)}{44}$

PWM0 — PWM REGISTER 0

bit	7	6	5	4	3	2	1	0
default	1	0	0	0	0	0	0	0

The PWM0 register determines the duty cycle of BLINK0. The outputs are LOW (LED off) when the count is less than the value in PWM0 and HIGH when it is greater. If PWM0 is programmed with 00h, then the PWM0 output is always LOW.

The duty cycle of BLINK0 is: $\dfrac{256 - PWM0}{256}$

PSC1 — FREQUENCY PRESCALER 1

bit	7	6	5	4	3	2	1	0
default	1	1	1	1	1	1	1	1

PSC1 is used to program the period of PWM output.

The period of BLINK1 $= \dfrac{(PSC1\ +\ 1)}{44}$

PWM1 — PWM REGISTER 1

bit	7	6	5	4	3	2	1	0
default	1	0	0	0	0	0	0	0

The PWM1 register determines the duty cycle of BLINK1. The outputs are LOW (LED off) when the count is less than the value in PWM1 and HIGH when it is greater. If PWM1 is programmed with 00h, then the PWM1 output is always LOW.

The duty cycle of BLINK1 is: $\dfrac{256 - PWM1}{256}$

4-bit I²C-bus LED driver with programmable blink rates

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LS0 — LED SELECTOR

	LED3		LED2		LED 1		LED 0	
bit	7	6	5	4	3	2	1	0
default	0	1	0	1	0	1	0	1

The LSx LED select registers determine the source of the LED data.

   00 = Output is set LOW (LED on)
   01 = Output is set high-impedance (LED off – default)
   10 = Output blinks at PWM0 rate
   11 = Output blinks at PWM1 rate

PINS USED AS GENERAL PURPOSE I/Os

LED pins not used to control LEDs can be used as general purpose I/Os.

For use as input: Set LEDx to high-impedance (01) and then read the pin state via the input register.

For use as output: Connect external pull-up resistor to the pin and size it according to the DC recommended operating characteristics. LED output pin is HIGH when the output is programmed as high-impedance, and LOW when the output is programmed LOW through the "LED selector" register. The output can be pulse-width controlled when PWM0 or PWM1 are used.

POWER-ON RESET

When power is applied to V_{DD}, an internal Power-On Reset (POR) holds the PCA9553 in a reset condition until V_{DD} has reached V_{POR}. At this point, the reset condition is released and the PCA9553 registers are initialized to their default states, with all outputs in the off state. Thereafter, V_{DD} must be lowered below 0.2 V to reset the device.

4-bit I^{2}C-bus LED driver with programmable blink rates

PCA9553

CHARACTERISTICS OF THE I^{2}C-BUS

The I^{2}C-bus is for 2-way, 2-line communication between different ICs or modules. The two lines are a serial data line (SDA) and a serial clock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time will be interpreted as control signals (see Figure 6).
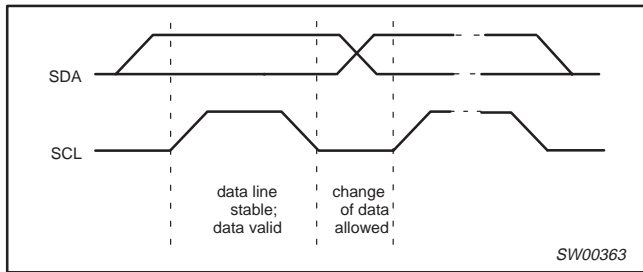

Figure 6. Bit transfer

Start and stop conditions

Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line, while the clock is HIGH is defined as the start condition (S). A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the stop condition (P) (see Figure 7).

System configuration

A device generating a message is a transmitter: a device receiving is the receiver. The device that controls the message is the master and the devices which are controlled by the master are the slaves (see Figure 8).
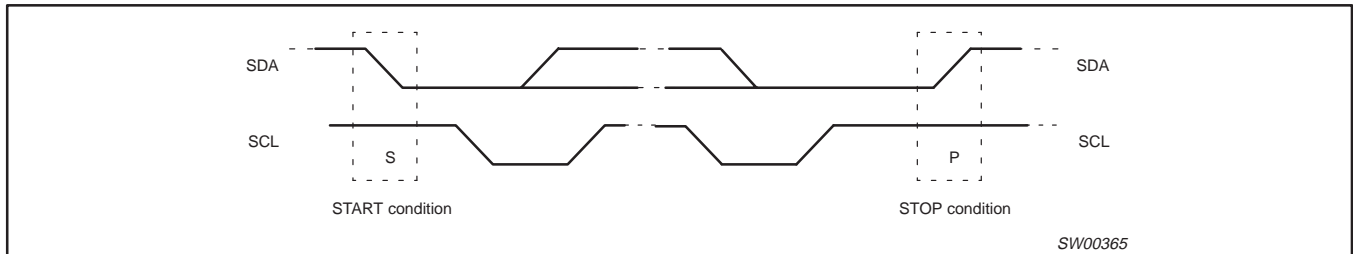

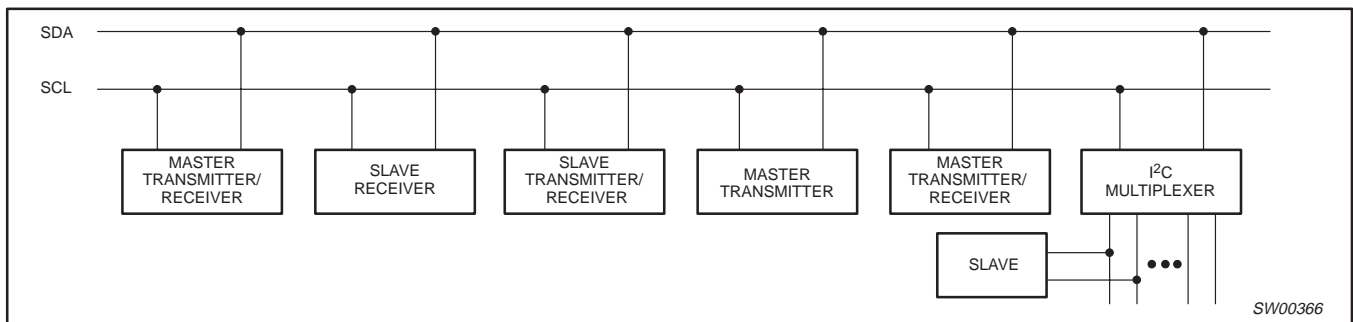**Figure 7. Definition of start and stop conditions**

Figure 8. System configuration

Acknowledge

The number of data bytes transferred between the start and the stop conditions from transmitter to receiver is not limited. Each byte of eight bits is followed by one acknowledge bit. The acknowledge bit is a HIGH level put on the bus by the transmitter whereas the master generates an extra acknowledge related clock pulse.

A slave receiver which is addressed must generate an acknowledge after the reception of each byte. Also a master must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter. The device that acknowledges has to pull down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse, set-up and hold times must be taken into account.

A master receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event, the transmitter must leave the data line HIGH to enable the master to generate a stop condition.
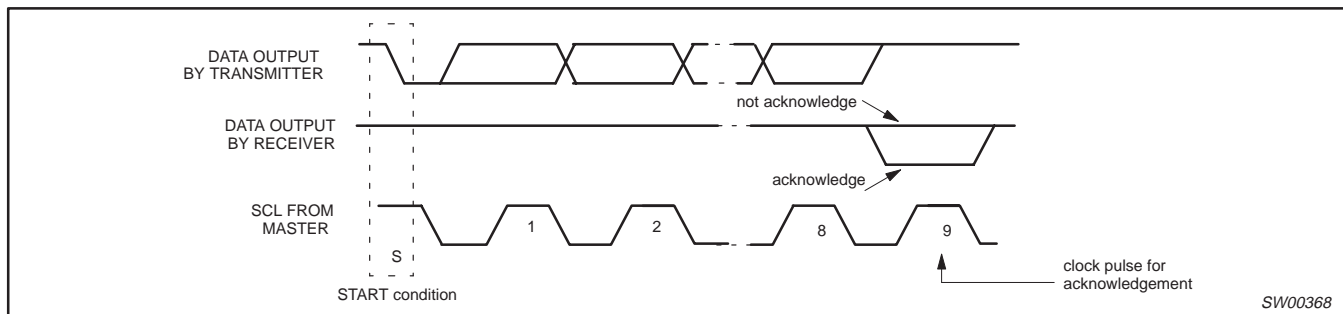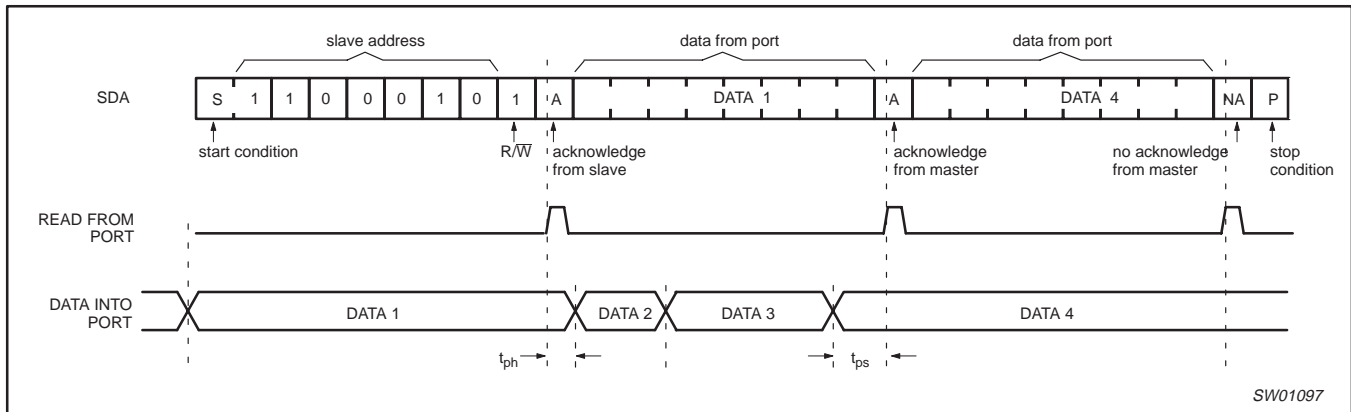

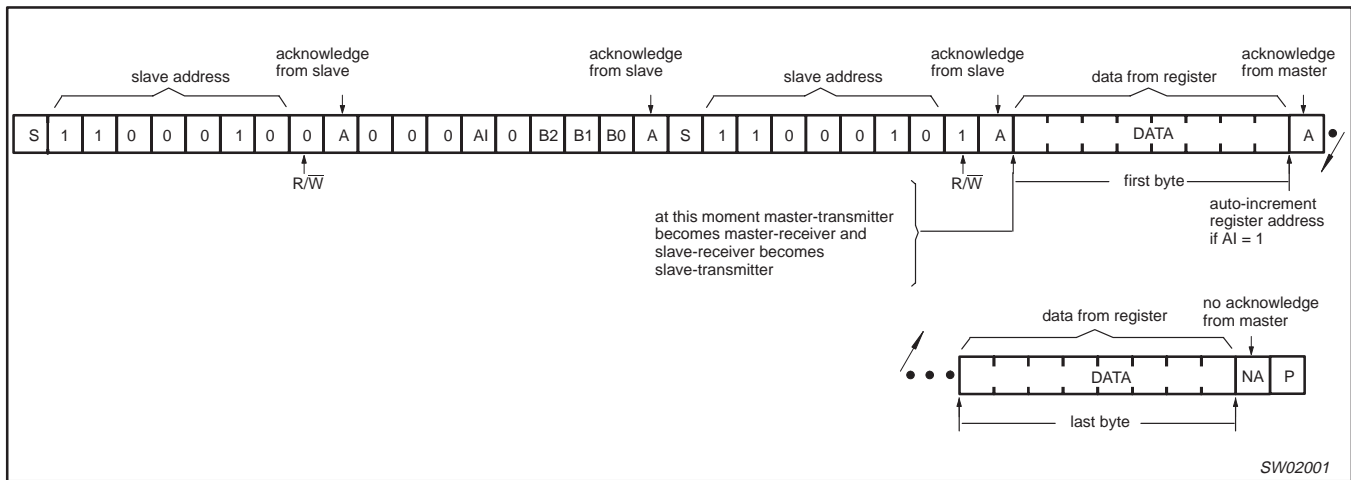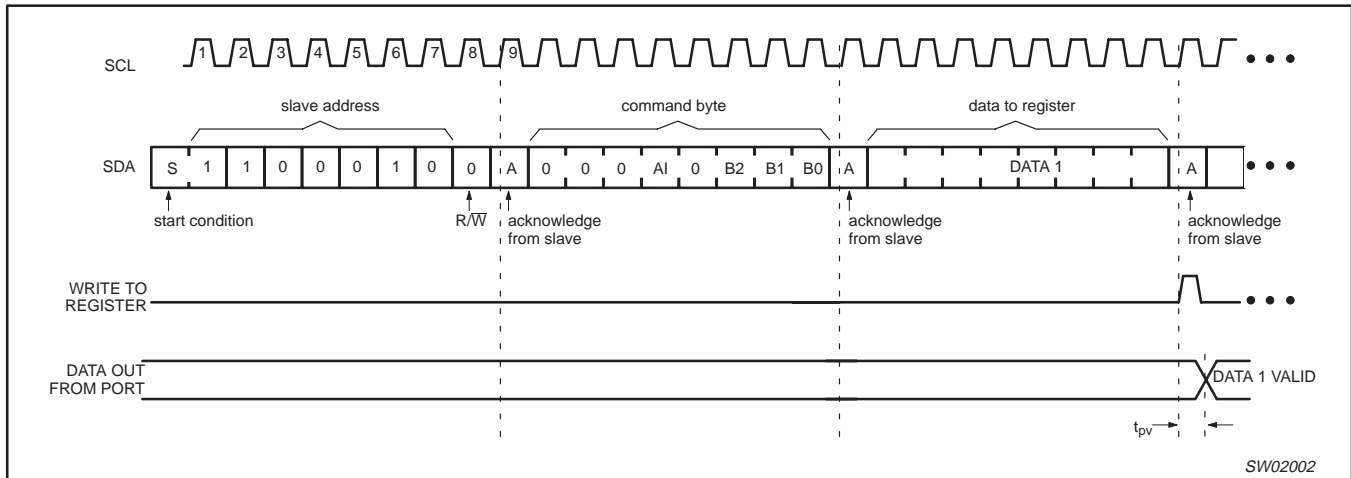**Figure 9. Acknowledgement on the I^{2}C-bus**

4-bit I²C-bus LED driver with programmable blink rates

PCA9553

Bus transactions

Figure 10. Write to register

Figure 11. Read from register

NOTES:
1. This figure assumes the command byte has previously been programmed with 00h.
2. PCA9553/01 shown.

Figure 12. Read input port register
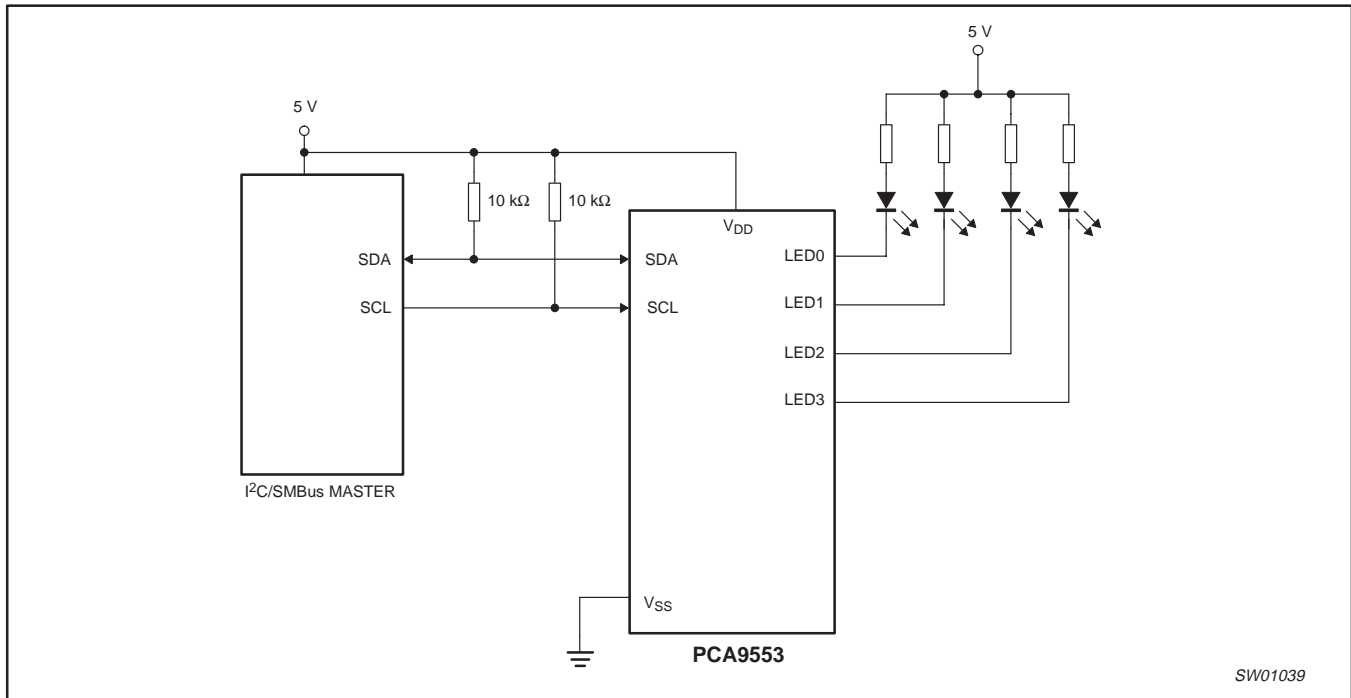
APPLICATION DATA

Figure 13. Typical application

Minimizing I_{DD} when the I/O is used to control LEDs

When the I/Os are used to control LEDs, they are normally connected to V_{DD} through a resistor as shown in Figure 13. Since the LED acts as a diode, when the LED is off the I/O V_{IN} is about 1.2 V less than V_{DD}. The supply current, I_{DD}, increases as V_{IN} becomes lower than V_{DD} and is specified as ΔI_{DD} in the DC characteristics table.

Designs needing to minimize current consumption, such as battery power applications, should consider maintaining the I/O pins greater than or equal to V_{DD} when the LED is off. Figure 14 shows a high value resistor in parallel with the LED. Figure 15 shows V_{DD} less than the LED supply voltage by at least 1.2 V. Both of these methods maintain the I/O V_{IN} at or above V_{DD} and prevents additional supply current consumption when the LED is off.
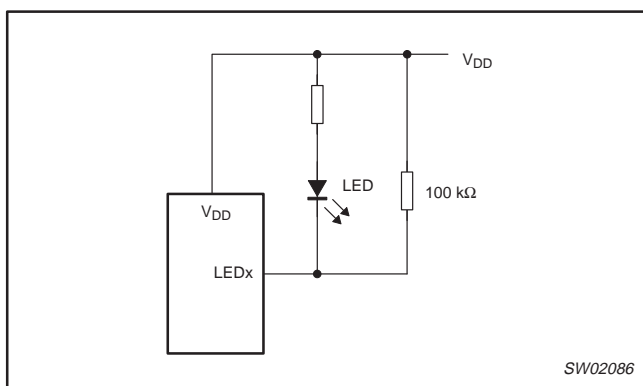

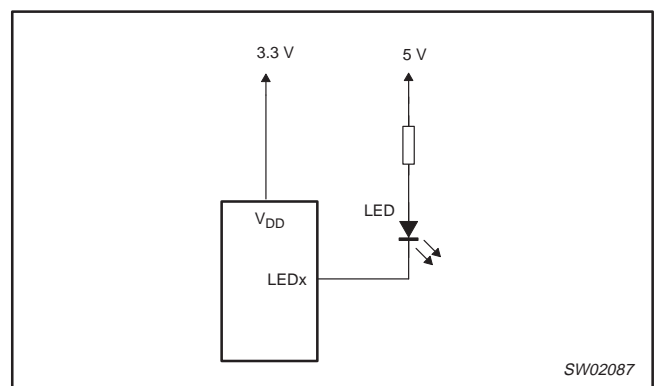**Figure 14. High value resistor in parallel with the LED**

Figure 15. Device supplied by a lower voltage

4-bit I^{2}C-bus LED driver with programmable blink rates

PCA9553

Programming example

The following example will show how to set LED0 and LED1 off. It will then set LED2 to blink at 1 Hz, 50% duty cycle. LED3 will be set to blink at 4 Hz, 25% duty cycle. PCA9553/01 is used in this example.

Table 1.

	I^{2}C-bus
Start	S
PCA9553 address	C4h
PSC0 subaddress + auto-increment	11h
Set prescaler PSC0 to achieve a period of 1 second: $\qquad \text{Blink period} = 1 = \dfrac{PSC0 + 1}{44}$ $\qquad PSC0 = 43$	2Bh
Set PWM0 duty cycle to 50%: $\qquad \dfrac{256 - PWM0}{256} = 0.5$ $\qquad PWM0 = 128$	80h
Set prescaler PWM1 to achieve a period of 0.25 seconds: $\qquad \text{Blink period} = 0.25 = \dfrac{PSC1 + 1}{44}$ $\qquad PSC1 = 10$	0Ah
Set PWM1 output duty cycle to 25%: $\qquad \dfrac{256 - PWM1}{256} = 0.25$ $\qquad PWM1 = 192$	C0h
Set LED0 on, LED1 off, LED2 set to blink at PSC0, PWM0, LED3 set to blink at PCS1, PWM1	E4h
Stop	P

4-bit I²C-bus LED driver with programmable blink rates   PCA9553

ABSOLUTE MAXIMUM RATINGS

In accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNIT
V_{DD}	Supply voltage		−0.5	6.0	V
$V_{I/O}$	DC voltage on an I/O		V_{SS} − 0.5	5.5	V
$I_{I/O}$	DC output current on an I/O		—	±25	mA
I_{SS}	Supply current		—	100	mA
P_{tot}	Total power dissipation		—	400	mW
T_{stg}	Storage temperature range		−65	+150	°C
T_{amb}	Operating ambient temperature		−40	+85	°C

HANDLING

Inputs and outputs are protected against electrostatic discharge in normal handling. However, to be totally safe, it is desirable to take precautions appropriate to handling MOS devices. Advice can be found in Data Handbook IC24 under "*Handling MOS devices*".

DC CHARACTERISTICS

V_{DD} = 2.3 V to 5.5 V; V_{SS} = 0 V; T_{amb} = −40 °C to +85 °C; unless otherwise specified. TYP at 3.3 V and 25 °C.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
Supplies						
V_{DD}	Supply voltage		2.3	—	5.5	V
I_{DD}	Supply current	Operating mode; V_{DD} = 5.5 V; no load; $V_I = V_{DD}$ or V_{SS}; f_{SCL} = 100 kHz	—	350	500	µA
I_{stb}	Standby current	Standby mode; V_{DD} = 5.5 V; no load; $V_I = V_{DD}$ or V_{SS}; f_{SCL} = 100 kHz	—	1.9	3.0	µA
ΔI_{DD}	Additional standby current	Standby mode; V_{DD} = 5.5 V; Every LED I/O at V_{IN} = 4.3 V; f_{SCL} = 0 kHz	—	—	325	µA
V_{POR}	Power-on reset voltage (Note 1)	No load; $V_I = V_{DD}$ or V_{SS}	—	1.7	2.2	V
Input SCL; input/output SDA						
V_{IL}	LOW-level input voltage		−0.5	—	$0.3V_{DD}$	V
V_{IH}	HIGH-level input voltage		$0.7V_{DD}$	—	5.5	V
I_{OL}	LOW-level output current	V_{OL} = 0.4 V	3	6.5	—	mA
I_L	Leakage current	$V_I = V_{DD} = V_{SS}$	−1	—	+1	µA
C_I	Input capacitance	$V_I = V_{SS}$	—	3.7	5	pF
I/Os						
V_{IL}	LOW-level input voltage		−0.5	—	0.8	V
V_{IH}	HIGH-level input voltage		2.0	—	5.5	V
I_{OL}	LOW-level output current	V_{OL} = 0.4 V; V_{DD} = 2.3 V; Note 2	9	—	—	mA
		V_{OL} = 0.4 V; V_{DD} = 3.0 V; Note 2	12	—	—	mA
		V_{OL} = 0.4 V; V_{DD} = 4.5 V; Note 2	15	—	—	mA
		V_{OL} = 0.7 V; V_{DD} = 2.3 V; Note 2	15	—	—	mA
		V_{OL} = 0.7 V; V_{DD} = 3.0 V; Note 2	20	—	—	mA
		V_{OL} = 0.7 V; V_{DD} = 4.5 V; Note 2	25	—	—	mA
I_L	Input leakage current	V_{DD} = 3.6 V; V_I = 0 V or V_{DD}	−1	—	1	µA
C_{IO}	Input/output capacitance		—	2.1	5	pF

NOTES:
1. V_{DD} must be lowered to 0.2 V in order to reset part.
2. Each I/O must be externally limited to a maximum of 25 mA and the device must be limited to a maximum current of 100 mA.

4-bit I^{2}C-bus LED driver with programmable blink rates

PCA9553

AC SPECIFICATIONS

SYMBOL	PARAMETER	STANDARD MODE I^{2}C-BUS		FAST MODE I^{2}C-BUS		UNITS
		MIN	MAX	MIN	MAX	
f_{SCL}	Operating frequency	0	100	0	400	kHz
t_{BUF}	Bus free time between STOP and START conditions	4.7	—	1.3	—	µs
$t_{HD;STA}$	Hold time after (repeated) START condition	4.0	—	0.6	—	µs
$t_{SU;STA}$	Repeated START condition set-up time	4.7	—	0.6	—	µs
$t_{SU;STO}$	Set-up time for STOP condition	4.0	—	0.6	—	µs
$t_{HD;DAT}$	Data in hold time	0	—	0	—	ns
$t_{VD;ACK}$	Valid time for ACK condition[2]	—	600	—	600	ns
$t_{VD;DAT}$ (L)	Data out valid time[3]	—	600	—	600	ns
$t_{VD;DAT}$ (H)	Data out valid time[3]	—	1500	—	600	ns
$t_{SU;DAT}$	Data set-up time	250	—	100	—	ns
t_{LOW}	Clock LOW period	4.7	—	1.3	—	µs
t_{HIGH}	Clock HIGH period	4.0	—	0.6	—	µs
t_F	Clock/Data fall time	—	300	$20 + 0.1\ C_b$[1]	300	ns
t_R	Clock/Data rise time	—	1000	$20 + 0.1\ C_b$[1]	300	ns
t_{SP}	Pulse width of spikes that must be suppressed by the input filters	—	50	—	50	ns
Port Timing						
t_{PV}	Output data valid	—	200	—	200	ns
t_{PS}	Input data set-up time	100	—	100	—	ns
t_{PH}	Input data hold time	1	—	1	—	µs

NOTES:
1. C_b = total capacitance of one bus line in pF.
2. $t_{VD;ACK}$ = time for Acknowledgement signal from SCL LOW to SDA (out) LOW.
3. $t_{VD;DAT}$ = minimum time for SDA data out to be valid following SCL LOW.

4-bit I²C-bus LED driver with programmable blink rates
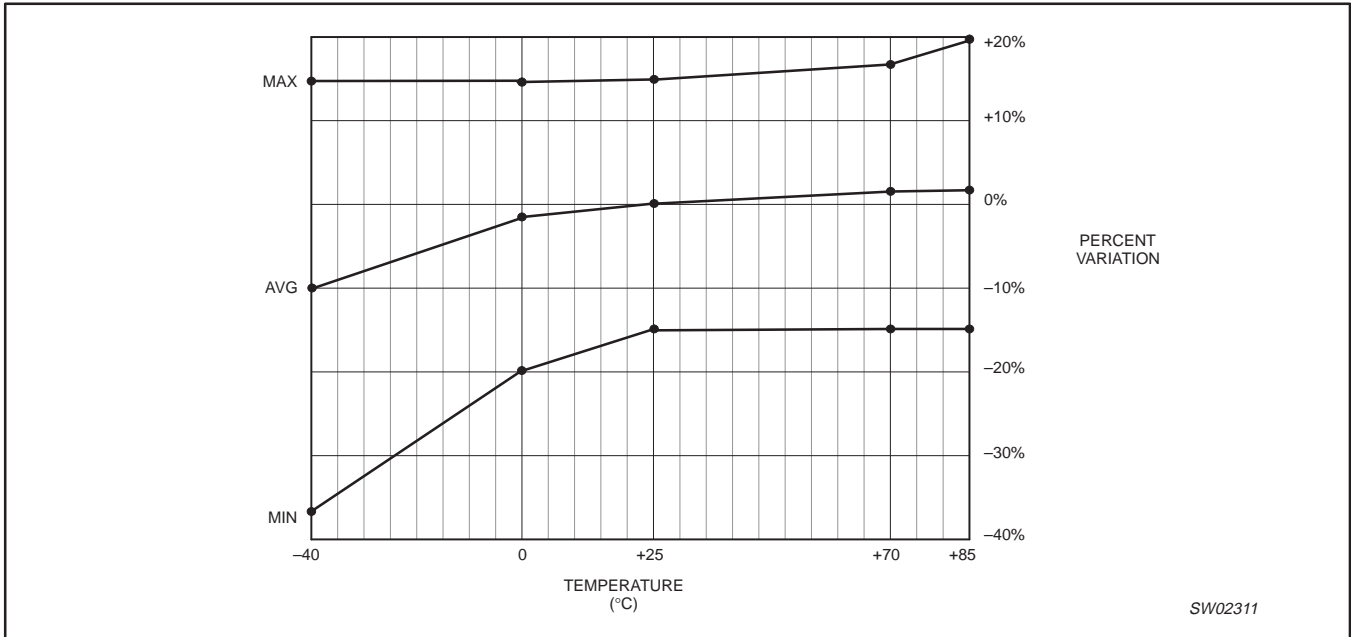
PCA9553

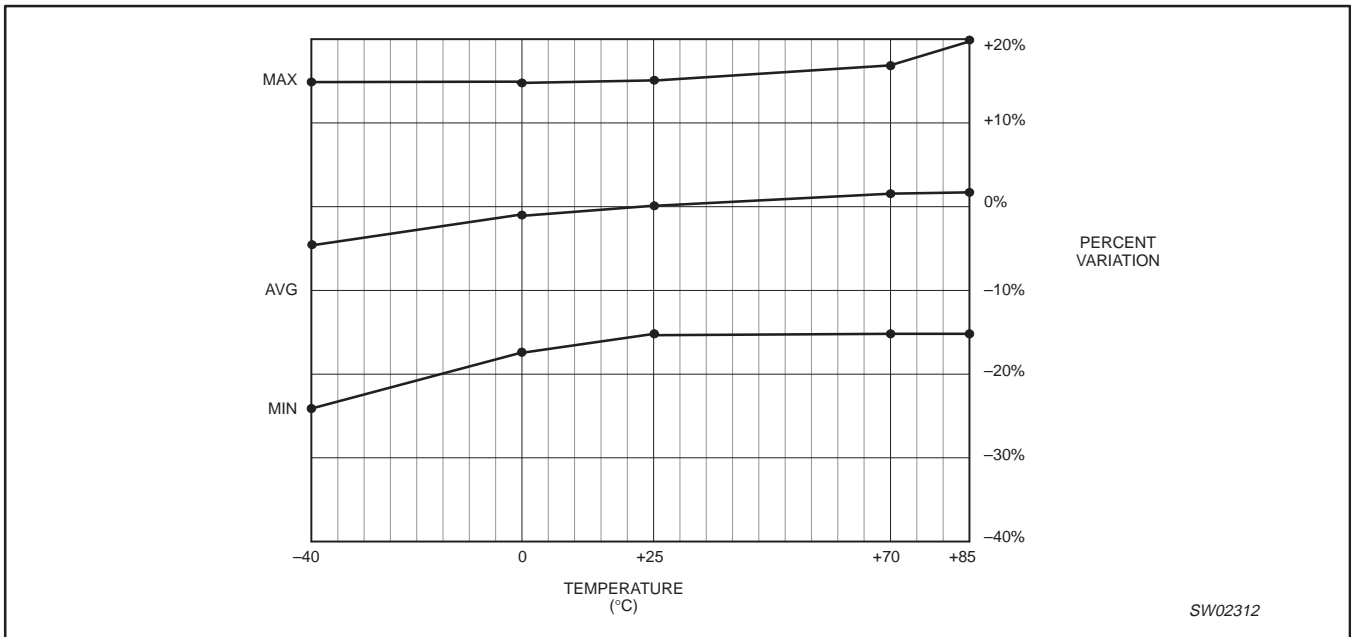**Figure 16. Typical frequency variation over process at V_DD = 2.3 V to 3.0 V**

Figure 17. Typical frequency variation over process at V_DD = 3.0 V to 5.5 V
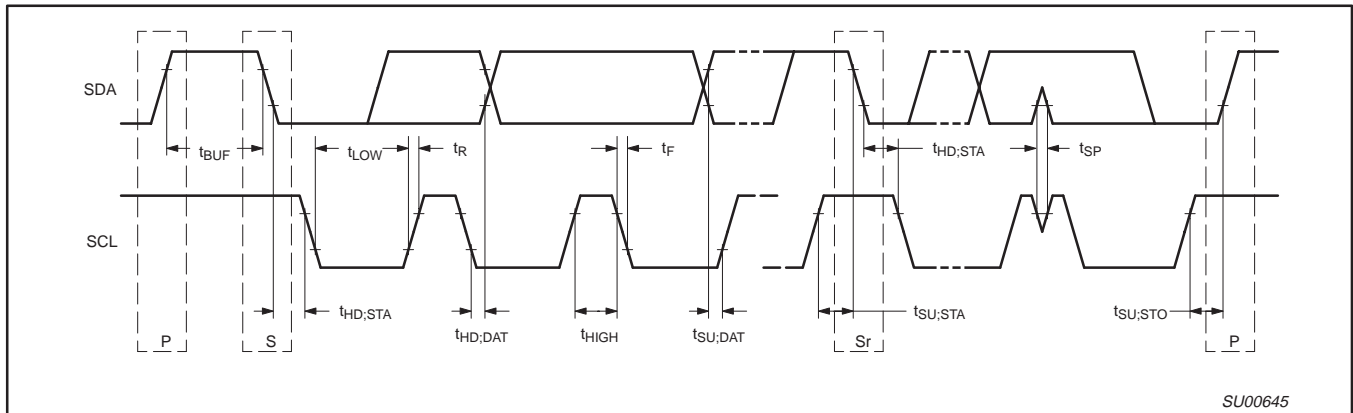
Figure 18. Definition of timing
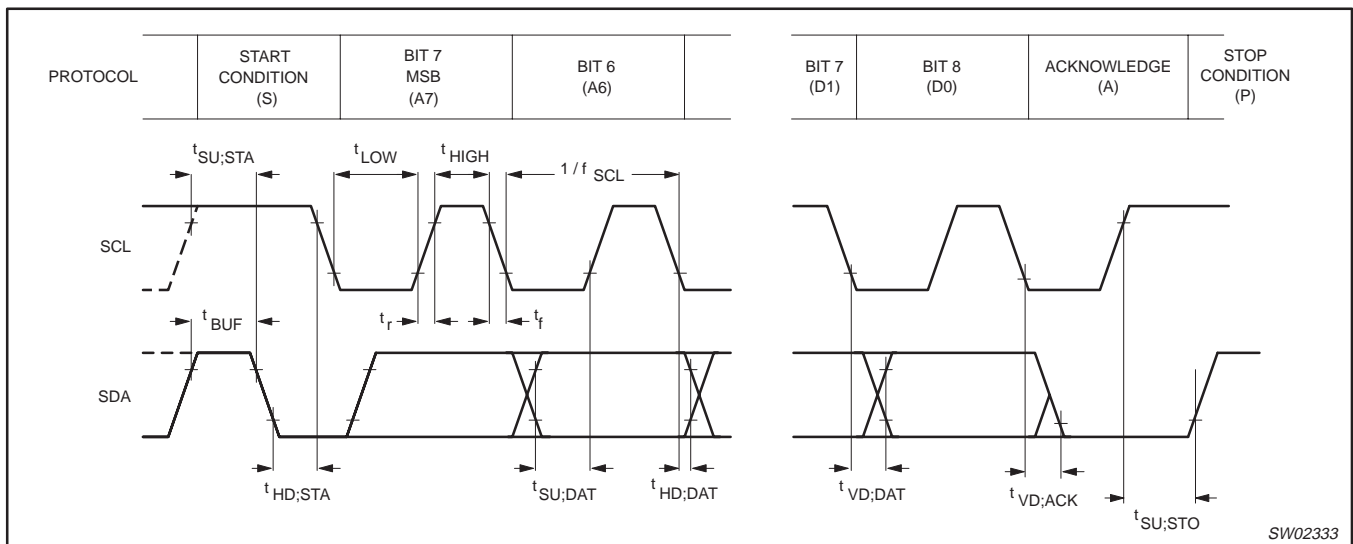
Figure 19. I²C-bus timing diagram; rise and fall times refer to V_{IL} and V_{IH}

DEFINITIONS

R_L = Load resistor FOR LEDN. R_L FOR SDA AND SCL > 1 kΩ (3 mA or less current).

C_L = Load capacitance includes jig and probe capacitance

R_T = Termination resistance should be equal to the output impedance Z_O of the pulse generators.
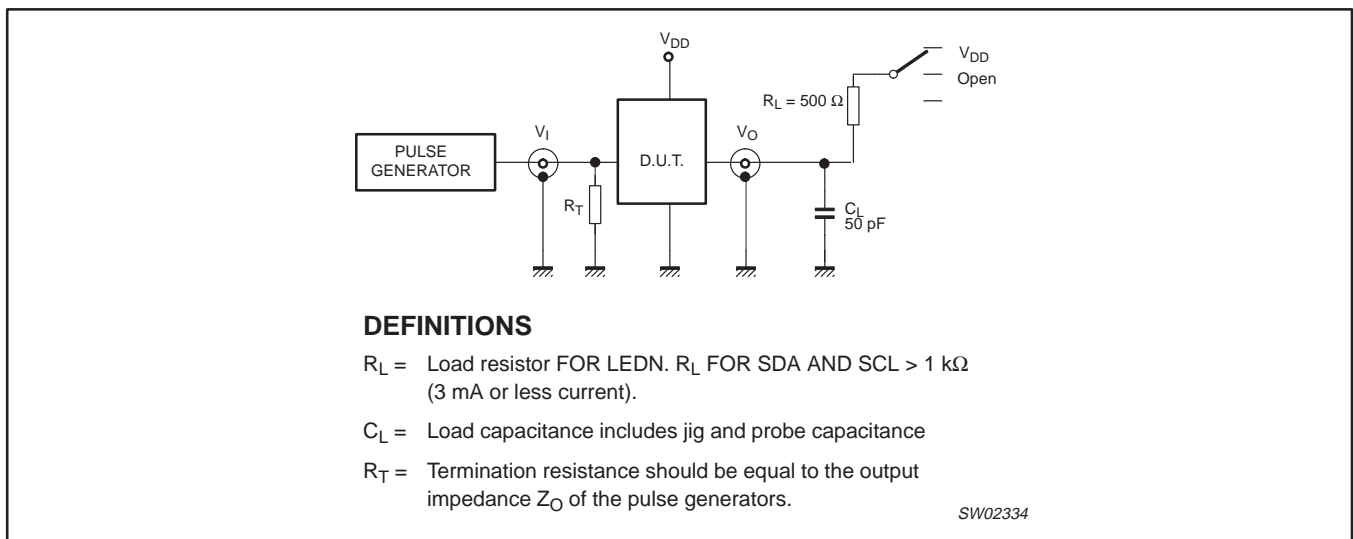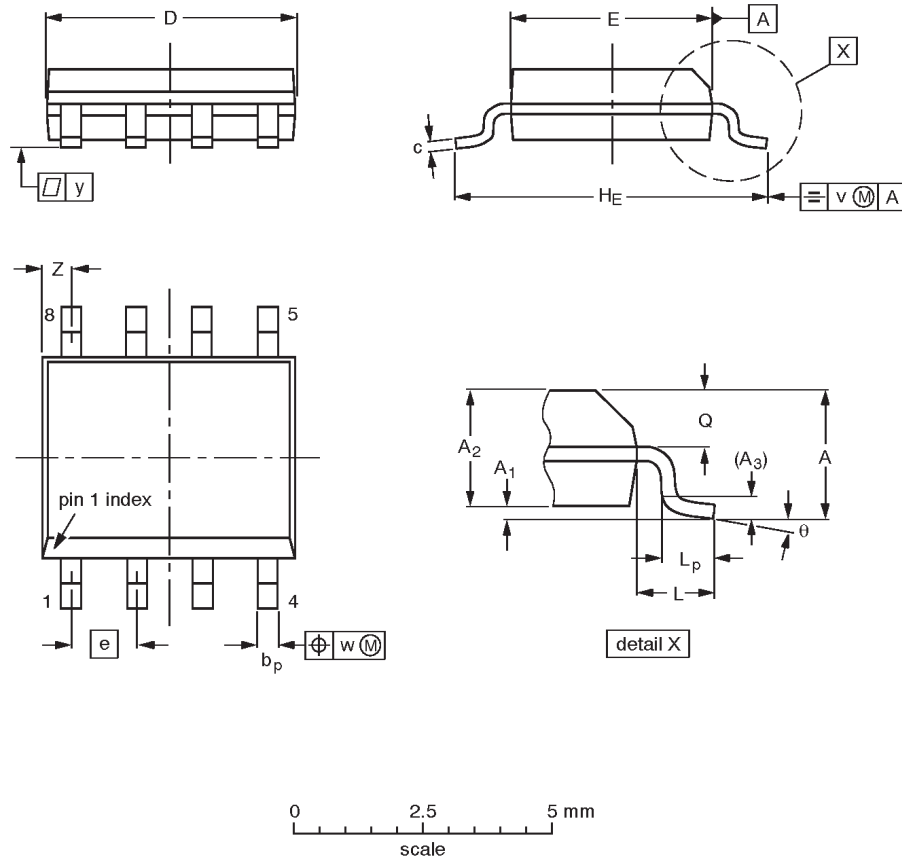
Figure 20. Test circuitry for switching times

4-bit I²C-bus LED driver with programmable blink rates

PCA9553

SO8: plastic small outline package; 8 leads; body width 3.9 mm

SOT96-1

pin 1 index

detail X

0   2.5   5 mm
scale

DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A₁	A₂	A₃	b_p	c	D(1)	E(2)	e	H_E	L	L_p	Q	v	w	y	Z(1)	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	5.0 4.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8° 0°
inches	0.069	0.010 0.004	0.057 0.049	0.01	0.019 0.014	0.0100 0.0075	0.20 0.19	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	

Notes

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.
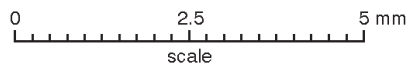2. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

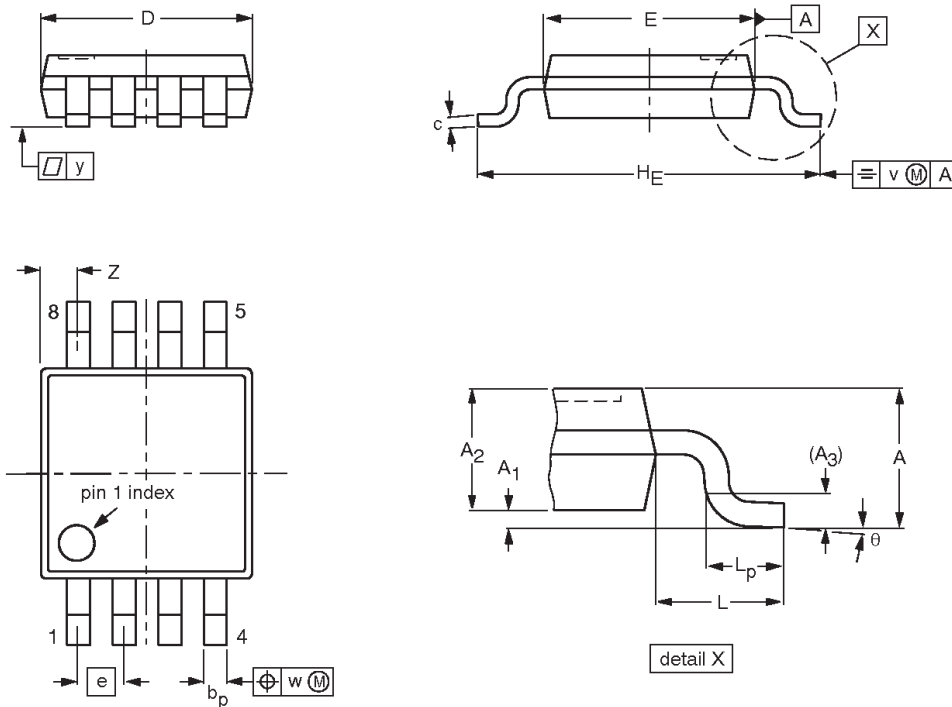| OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT96-1	076E03	MS-012				99-12-27 03-02-18

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm

SOT505-1

DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A$_1$	A$_2$	A$_3$	b$_p$	c	D$^{(1)}$	E$^{(2)}$	e	H$_E$	L	L$_p$	v	w	y	Z$^{(1)}$	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.45 0.25	0.28 0.15	3.1 2.9	3.1 2.9	0.65	5.1 4.7	0.94	0.7 0.4	0.1	0.1	0.1	0.70 0.35	6° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
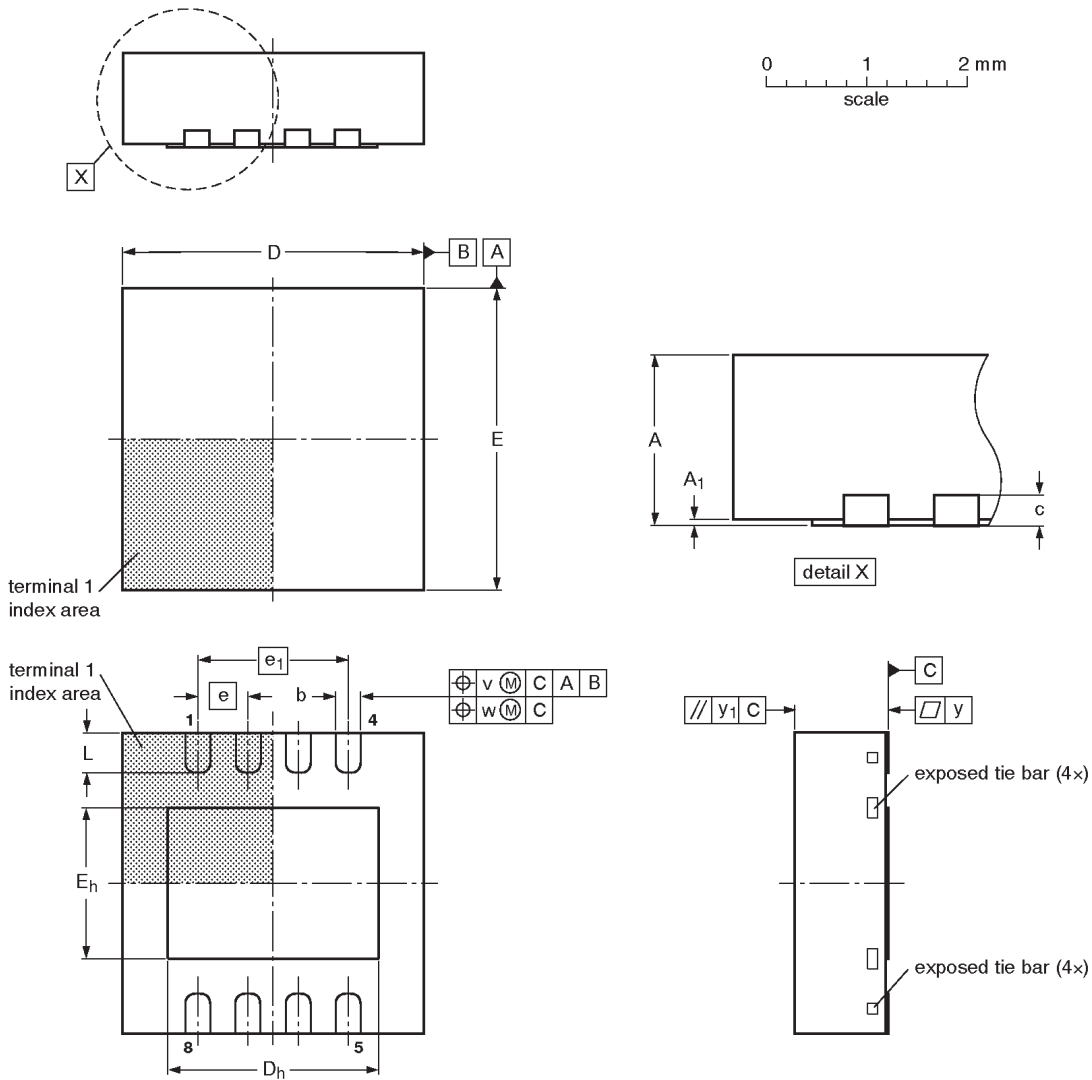2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT505-1						~~99-04-09~~ 03-02-18

**HVSON8:   plastic thermal enhanced very thin small outline package; no leads;   SOT908-1
8 terminals; body 3 x 3 x 0.85 mm**

terminal 1
index area

terminal 1
index area

detail X

exposed tie bar (4×)

exposed tie bar (4×)

DIMENSIONS (mm are the original dimensions)

UNIT	A(1) max.	A₁	b	c	D(1)	Dₕ	E(1)	Eₕ	e	e₁	L	v	w	y	y₁
mm	1	0.05 0.00	0.3 0.2	0.2	3.1 2.9	2.25 1.95	3.1 2.9	1.65 1.35	0.5	1.5	0.5 0.3	0.1	0.05	0.05	0.1

Note

1. Plastic or metal protrusions of 0.075 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT908-1		MO-229				~~05-09-26~~ 05-10-05

REVISION HISTORY

Rev	Date	Description
_4	20060818	**Product data sheet. Supersedes data of 2004 Oct 01 (9397 750 13728).** Modifications: • "Features" section on page 2: – last bullet: added "HVSON8" • Ordering information table on page 2: added "HVSON8" package offering. • "Device addressing" section on page 4: added second paragraph. • Package outlines: added HVSON8 package outline drawing SOT908-1.
_3	20041001	**Product data sheet (9397 750 13728). Supersedes data of 2003 May 02 (9397 750 11464).**
_2	20030502	**Product data (9397 750 11464); ECN 853-2397 29856 Dated 24 April2003.** **Supersedes data of 2002 Dec 13 (9397 750 10859).**
_1	20021213	**Product data (9397 750 10859); ECN 853–2397 29264 of 09 December 2002.**

4-bit I^{2}C-bus LED driver with programmable blink rates   PCA9553

Legal Information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this data sheet was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.semiconductors.philips.com.

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